

# MOS FIELD EFFECT TRANSISTOR 2SK3055

## SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### DESCRIPTION

This product is N-Channel MOS Field Effect Transistor designed for high current switching applications.

#### FEATURES

- Low On-State Resistance  $R_{DS(on)1} = 34 \text{ m}\Omega \text{ MAX.}$  (VGs = 10 V, ID = 15 A)  $R_{DS(on)2} = 50 \text{ m}\Omega \text{ MAX.}$  (VGs = 4.0 V, ID = 15 A)
- Low Ciss : Ciss = 920 pF TYP.
- Built-in Gate Protection Diode
- Isolated TO-220 package

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

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Drain to Source Voltage	VDSS	60	V
Gate to Source Voltage	VGSS(AC)	±20	V
Gate to Source Voltage	VGSS(DC)	+20, -10	V
Drain Current (DC)	D(DC)	±30	Α
Drain Current (Pulse) Note1	D(pulse)	±100	А
Total Power Dissipation (Tc = 25°C)	Ρτ	25	W
Total Power Dissipation (T <sub>A</sub> = 25°C)	Ρτ	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
Single Avalanche Current Note2	las	15	А
Single Avalanche Energy Note2	Eas	22.5	mJ

#### **Notes 1.** PW $\leq$ 10 $\mu$ s, Duty cycle $\leq$ 1 %

**2.** Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0 V

#### THERMAL RESISTANCE

Channel to Case	Rth(ch-C)	5.0	°C/W
Channel to Ambient	Rth(ch-A)	62.5	°C/W

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## ORDERING INFORMATION

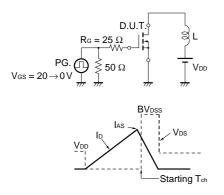
PART NUMBER	R PACKAGE	
2SK3055	Isolated TO-220	

NEC

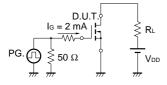
#### ELECTRICAL CHARACTERISTICS (TA = 25 °C)

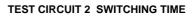
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Id = 15 A		24	34	mΩ
	RDS(on)2	Vgs = 4.0 V, Id = 15 A		35	50	mΩ
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	$V_{DS} = 10 V, I_{D} = 1 mA$	1.0	1.6	2.0	V
Forward Transfer Admittance	y <sub>fs</sub>	Vds = 10 V, Id = 15 A	8.0	20		S
Drain Leakage Current	IDSS	Vds = 60 V, Vgs = 0 V			10	μA
Gate to Source Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V		920		pF
Output Capacitance	Coss	Vgs = 0 V		280		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		120		pF
Turn-on Delay Time	td(on)	ID = 15 A		25		ns
Rise Time	tr	$V_{GS(on)} = 10 V$		300		ns
Turn-off Delay Time	td(off)	Vdd = 30 V		70		ns
Fall Time	tr	R <sub>G</sub> = 10 Ω		120		ns
Total Gate Charge	Q <sub>G</sub>	ID = 30 A		25		nC
Gate to Source Charge	QGS	V <sub>DD</sub> = 48 V		3.3		nC
Gate to Drain Charge	Qgd	VGS(on) = 10 V		7.0		nC
Body Diode Forward Voltage	VF(S-D)	IF = 30 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	If = 30 A, V <sub>GS</sub> = 0 V		45		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>µ</i> s		60		nC

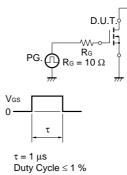
#### TEST CIRCUIT 1 AVALANCHE CAPABILITY

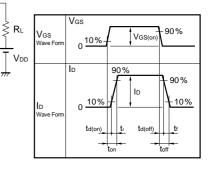


#### **TEST CIRCUIT 3 GATE CHARGE**

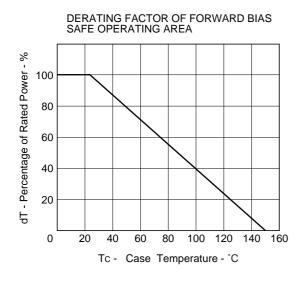




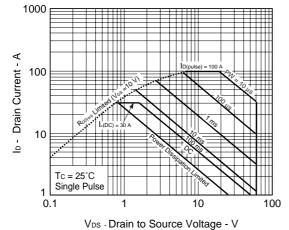




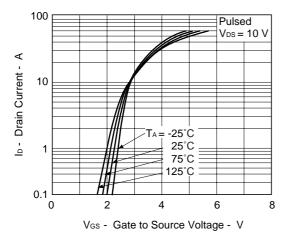
## TYPICAL CHARACTERISTICS (TA = 25 °C)

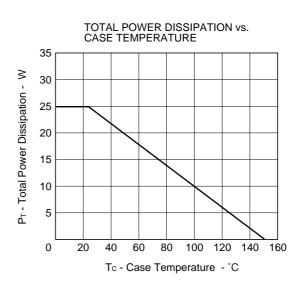




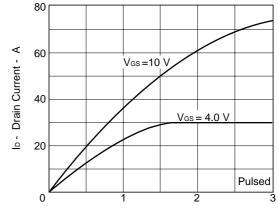


#### FORWARD TRANSFER CHARACTERISTICS

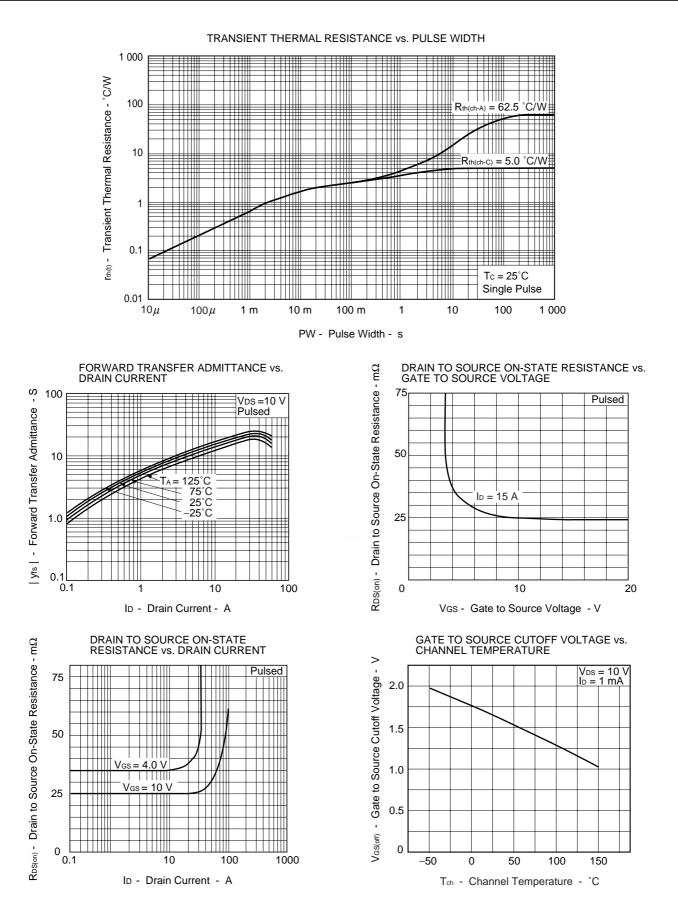




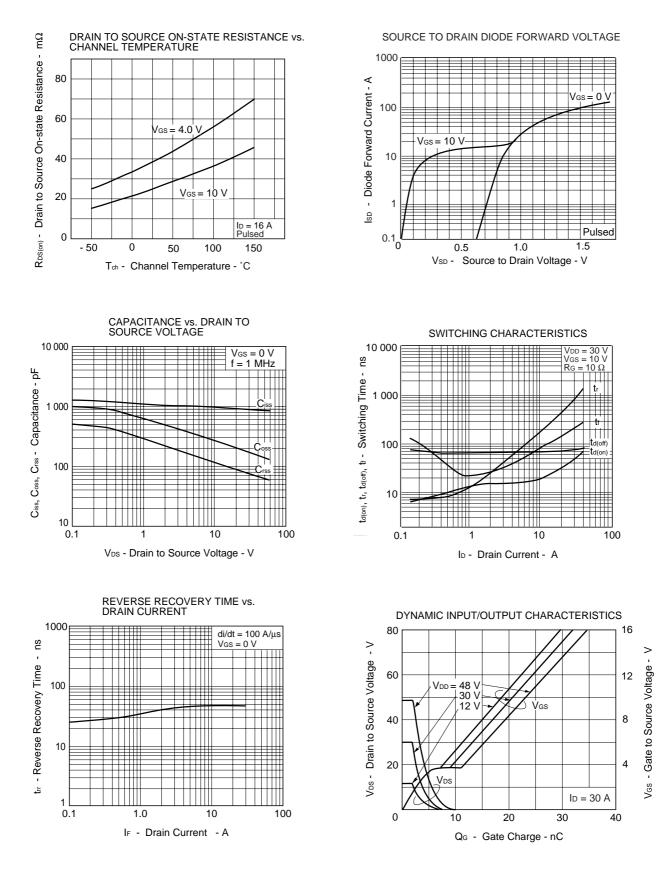




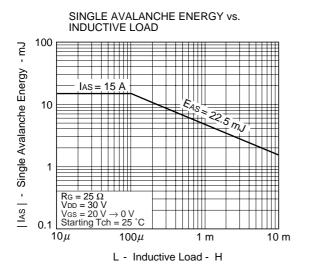
V<sub>DS</sub> - Drain to Source Voltage - V

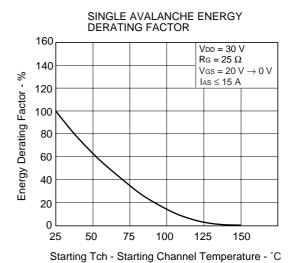


Data Sheet D13094EJ1V0DS00



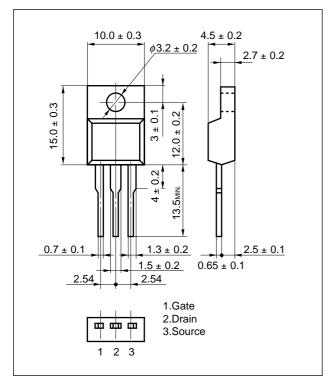
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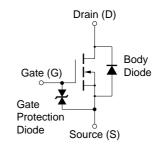


## PACKAGE DRAWING (Unit : mm)

Isolated TO-220 (MP-45F)



**EQUIVALENT CIRCUIT** 



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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